As a below named inventor, I hereby declare that:

My residence, post office and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter claimed and for which a patent is sought on the the sp

on the invention ent the specification of	itled NON-VOLAT	TILE MEMORY AND FABRICATION M	ETHOD THEREOF
the specification of	WIIICII		
is attache			
	l on	as Application Serial No.	
and was	amended on	(if applicable).	
I hereby state that I l the claims, as amend	have reviewed and u ded by any amendmo	understand the contents of the above identifient referred to above.	ied specification, including
I acknowledge the accordance with Title	duty to disclose in le 37, Code of Feder	formation which is known to me to be real Regulations, Section 1.56.	naterial to patentability in
application(s) for pa	atent or inventor's	s under Title 35, United States Code, Se certificate listed below and have also ide tificate having a filing date before that of	ntified below any foreign
Prior Foreign Appl	ications(s):		
Number	Country	Day/Month/Year filed	Priority Claimed
2002-202487	Japan	11/07/2002	

I hereby claim the benefit under 35 USC §119(e) of any United States provisional application(s) listed below.

Prior Provisional Application(s):

Application Number

Filing Date

I hereby claim the benefit under Title 35, United States Code, Section 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Section 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, Section 1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

Prior U.S. Application(s):

Serial No.

PCT/JP03/08349

Filing Date 01/07/2003 Status: Patented, Pending, Abandoned

Pending